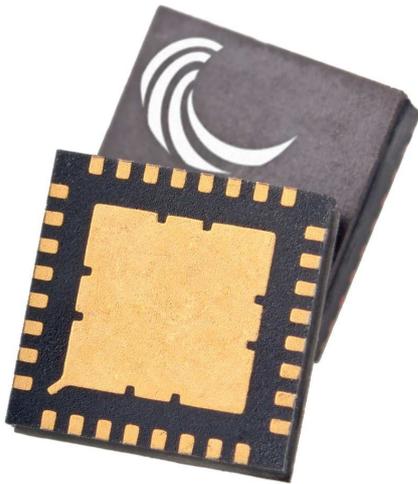


Linwave QFN Dual Stage PIN Limiter

LW48-700133



Features

- 20-2000MHz Passive, high isolation limiter
- Low loss Typically < 0.6dB
- Return Loss > 20dB
- Flat Leakage < +18dBm
- Input Power CW Survivability >10W
- Integrated DC Block on both input and output
- QFN dimensions 5.0 x 5.0 x 1.6 mm, 32 lead

Typical Applications

- LNA receiver chain protection
- Radar receiver protection

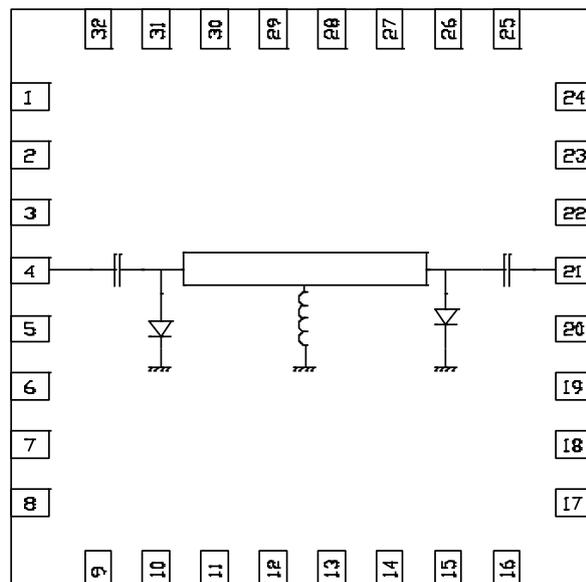
General Description

The LW48-700133 is an ultra-wideband two stage PIN diode limiter packaged in a leadless 5x5 mm surface mount package which operates between 20 and 2000 MHz. The limiter provides flat leakage of <+18dBm, return loss of >20dB with typical insertion loss of 0.5dB

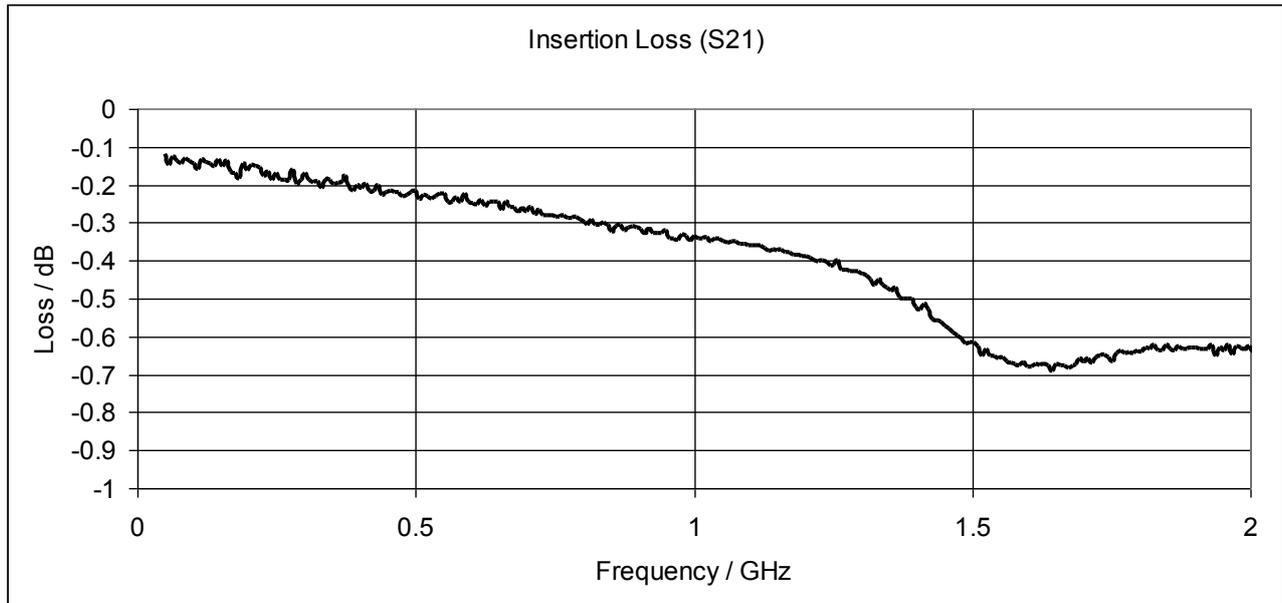
The LW48-700133 limiter input and output are internally matched to 50 Ohms and are internally DC blocked.

| Pin Designations | |
|------------------|----------|
| Pin No. | FUNCTION |
| Pin 4 | RF IN |
| Pin 21 | RF OUT |
| Pins 1-3, 5-20 | GROUND |
| Pins 22-32 | GROUND |

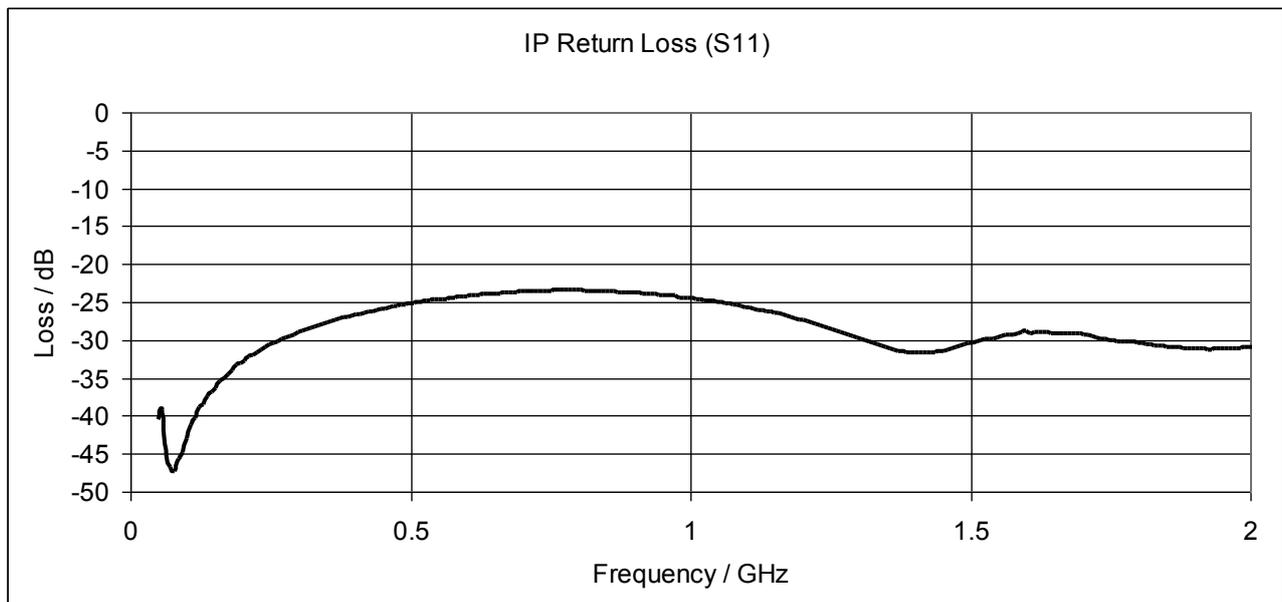
Functional Diagram



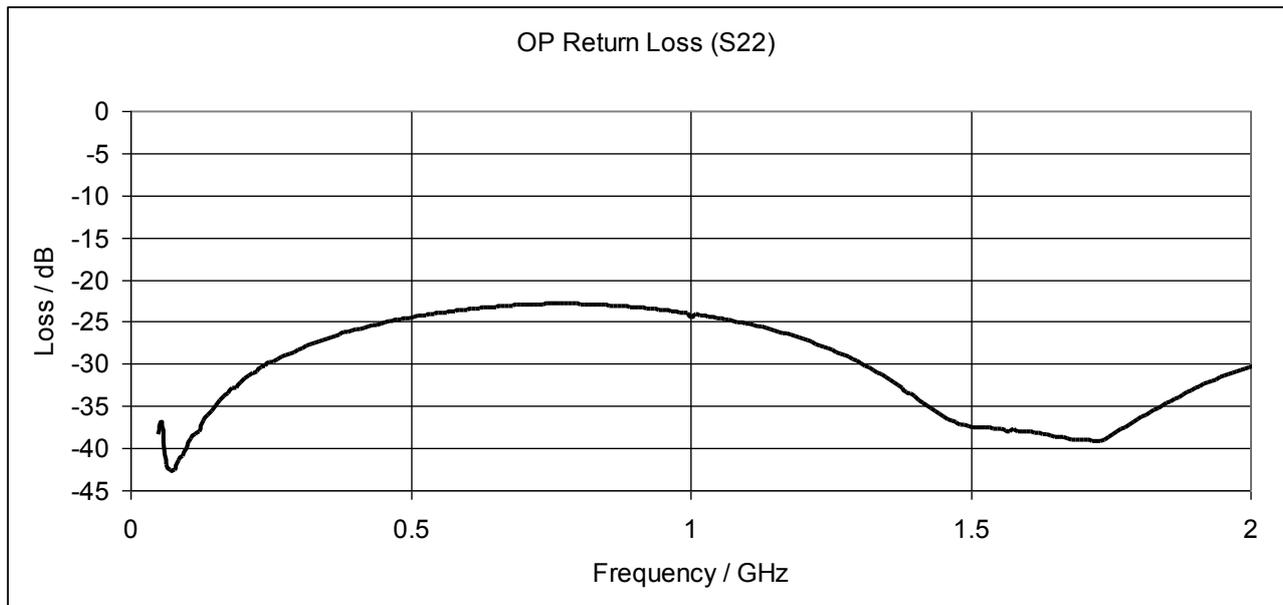
Insertion Loss



Input Return Loss



Output Return Loss



Limiting Characteristics

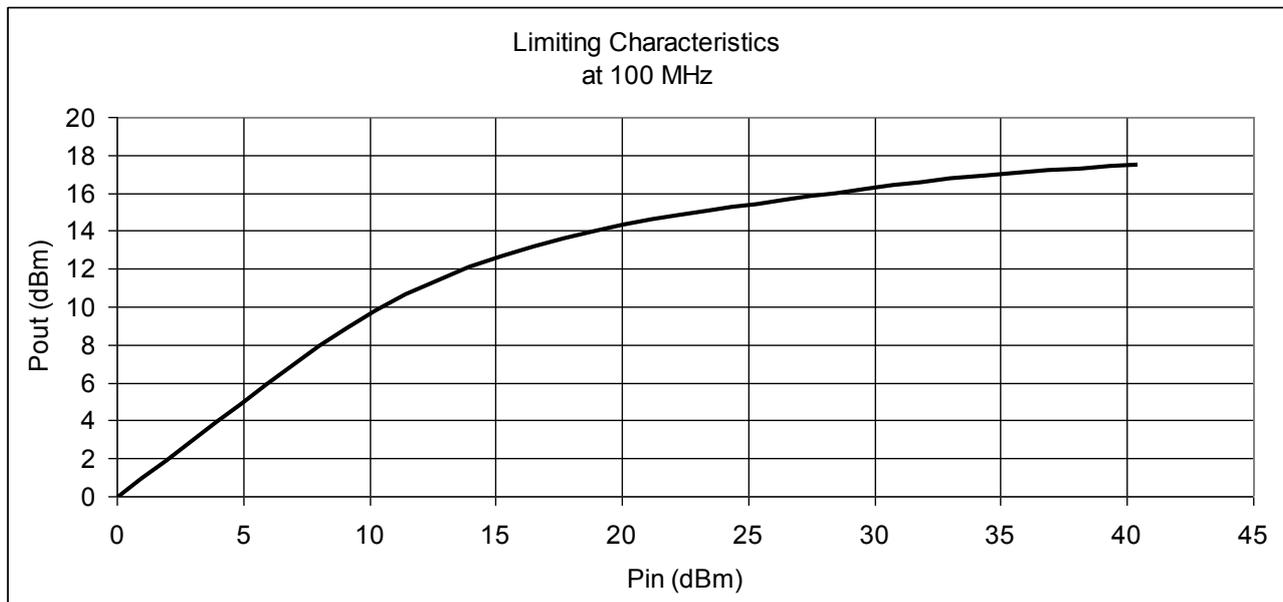


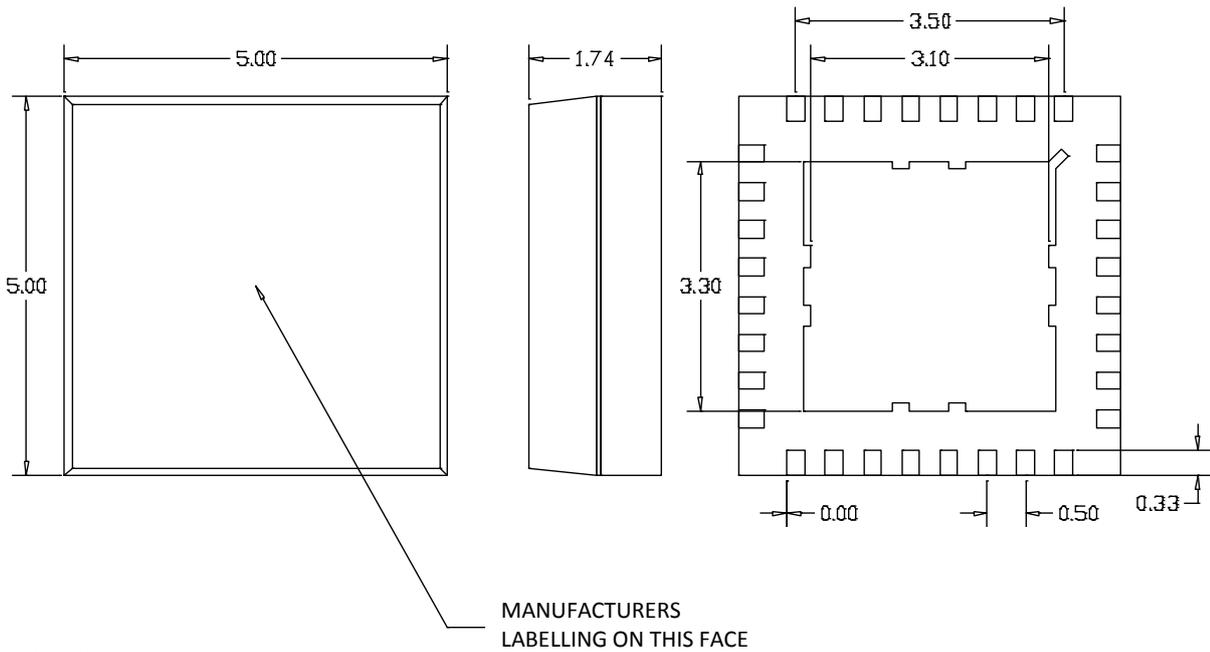
TABLE I
ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value |
|-----------|--------------------------------|---------------|
| P_{IN} | Input CW Power | +42dBm |
| T_M | Mounting Temperature (30 secs) | 260°C |
| T_{STG} | Storage Temperature | -55 to +125°C |
| T_{OP} | Operating Temperature | -40 to +85°C |

TABLE II
RF CHARACTERISTICS
($T_A = 25^\circ\text{C}$)

| Symbol | Parameter | Test Condition | Limit | | | Units |
|--------|--|--|-------|-----|--------|-------|
| | | | Min | Typ | Max | |
| F | Frequency Range | Swept Frequency | 20 | | 2000 | MHz |
| IL | Insertion Loss | Swept Frequency | | 0.5 | 0.9 | dB |
| IRL | Input Return Loss | Swept Frequency | 20 | | | dB |
| ORL | Output Return Loss | Swept Frequency | 20 | | | dB |
| PWR | Output Power @ Pin = +40dBm | F=100MHz | | 18 | | dBm |
| Pcw | CW Incident Power | Swept Frequency | | | 10 | W |
| Ppulse | Peak Incident Power | 1 μ s pulse width, 10% duty cycle | | | 100 | W |
| P1dB | Threshold Power | Swept Frequency | | +11 | | dBm |
| Pf | Flat Leakage Power | Swept Frequency, +10dBm CW | | +18 | | dBm |
| Es | Spike Leakage Energy | +50dBm, 1 μ s pulse, 10% duty | | 0.2 | | ergs |
| Tr | Recovery Time | +50dBm, 1 μ s pulse, 10% duty 50% trailing RF Pulse – 1dB IL) | | | 50 | |
| ILtemp | Insertion Loss Rate of Change with Operating Temperature | | | | -0.005 | dB/°C |

Outline Drawing



NOTES

- 1) BODY: PLASTIC, SEMICONDUCTOR GRADE
LID: LCP
- 2) LEAD FRAME: COPPER, 194 FH
- 3) LEAD FINISH: FULL GOLD PLATE ON FOOTPRINT
(1.27 μ m Au OVER 0.76 μ m Ni)
SIDE CONTACTS NON-PLATED
- 4) FRAME THICKNESS: 0.2030 \pm 0.0076
- 5) EXTERNAL DIMENSIONS \pm 0.15

Refer to Linwave application note for suggested PC Board Land Pattern.



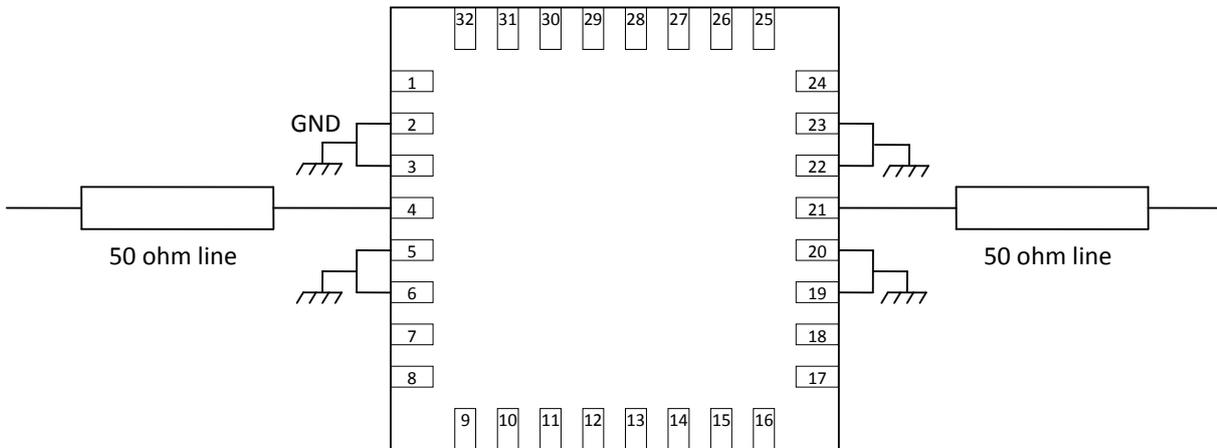
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Pin Descriptions

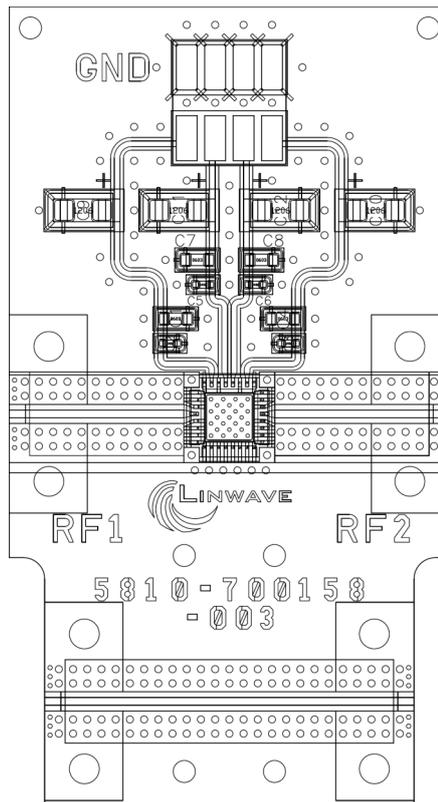
| Pin Number | Function | Description |
|------------------|----------|---|
| 4 | RF IN | This pad is AC coupled and matched to 50 ohms |
| 21 | RF OUT | This pad is AC coupled and matched to 50 ohms |
| 1,2, 6-19, 23-32 | N/C | The pins are not connected internally; however, all data shown was measured with these pins connected to RF/DC ground externally. |
| 3,5,20,22 | GROUND | Must be connected to RF/DC ground |
| Ground paddle | GROUND | Must be connected to RF/DC ground |

Application Circuit

Note: Effective heatsinking through the pallet on the underside is essential for high power operation (RF Input >1W)



Evaluation PCB



List of Materials for Evaluation PCB LW54-10133^[1]

| Item | Description |
|--------------------|---------------------------------|
| J1-J2 | Southwest Microwave 8100-302230 |
| U1 | LW48-700133 Limiter |
| PCB ^[2] | 5810-700158-003 Evaluation PCB |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit board material: Rogers 4350B on FR4 backing

The circuit board used in the application should use RF circuit design techniques. The signal lines should have 50 ohms impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Linwave upon request.